

Title (en)
MODULAR DATA CENTER

Title (de)
MODULARES DATENZENTRUM

Title (fr)
CENTRE DE DONNÉES MODULAIRE

Publication
EP 2567301 A4 20151007 (EN)

Application
EP 11804627 A 20110628

Priority
• US 201113080766 A 20110406
• US 2011042115 W 20110628

Abstract (en)
[origin: US2012255710A1] A building system for housing electronic equipment is described. The building system includes a building stack that includes an instrumentation modular building unit, with an internal configuration of space in the instrumentation modular building unit configured to house electronics equipment, a power modular building unit, with an internal configuration of space in the power modular building unit storing power distribution equipment, power filtering equipment and uninterruptable power supplies and further configured to deliver electronic power to the instrumentation modular building unit; and a cooling modular unit comprising an air conditioner unit and a water chiller unit, with the instrumentation modular building unit, the power unit modular building unit and the cooling modular unit stacked together.

IPC 8 full level
G06F 1/20 (2006.01); **E04H 5/00** (2006.01); **E04H 5/02** (2006.01); **H05K 7/14** (2006.01); **H05K 7/20** (2006.01)

CPC (source: EP US)
E04H 5/02 (2013.01 - EP US); **H05K 7/1497** (2013.01 - EP US); **H05K 7/20745** (2013.01 - EP US); **E04H 2005/005** (2013.01 - EP US)

Citation (search report)
• [X1] US 2010251629 A1 20101007 - CLIDARAS JIMMY [US], et al
• [XA1] WO 2011038348 A1 20110331 - AMAZON TECH INC [US], et al
• [XA] US 2010110626 A1 20100506 - SCHMITT TY [US], et al
• See references of WO 2012138362A1

Designated contracting state (EPC)
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

DOCDB simple family (publication)
US 2012255710 A1 20121011; **US 9945142 B2 20180417**; EP 2567301 A1 20130313; EP 2567301 A4 20151007; WO 2012138362 A1 20121011

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